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Additive manufacturing — General principles — Fundamentals and vocabulary

Fabrication additive — Principes généraux — Fondamentaux et vocabulaire



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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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This document was prepared by ISO/TC 261, *Additive manufacturing*, in cooperation with ASTM Committee F42, *Additive Manufacturing Technologies*, on the basis of a partnership agreement between ISO and ASTM International with the aim to create a common set of ISO/ASTM standards on additive manufacturing, and in collaboration with the European Committee for Standardization (CEN) Technical Committee CEN/TC 438, *Additive manufacturing*, in accordance with the Agreement on technical cooperation between ISO and CEN (Vienna Agreement).

This second edition of ISO/ASTM 52900 replaces the first edition (ISO/ASTM 52900:2015), which has been technically revised. The main changes compared to the previous edition are as follows:

- new and modified terms and definitions;
- abbreviations added for seven process categories;
- new annex for the specification of AM processes based on process categories and determining characteristics ([Annex A](#)).

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html.

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Introduction

Additive manufacturing (AM) is the general term for those technologies that successively join material to create physical objects as specified by 3D model data. These technologies are presently used for various applications in engineering industry as well as other areas of society, such as medicine, education, architecture, cartography, toys and entertainment.

During the development of additive manufacturing technology, there have been numerous different terms and definitions in use, often with reference to specific application areas and trademarks. This is often ambiguous and confusing, which hampers communication and wider application of this technology.

It is the intention of this document to provide a basic understanding of the fundamental principles for additive manufacturing processes, and based on this, to give clear definitions for terms and nomenclature associated with additive manufacturing technology. The objective of this standardization of terminology for additive manufacturing is to facilitate communication between people involved in this field of technology on a worldwide basis.